TOSHIBA Rectifier Silicon Diffused Type

CMG03

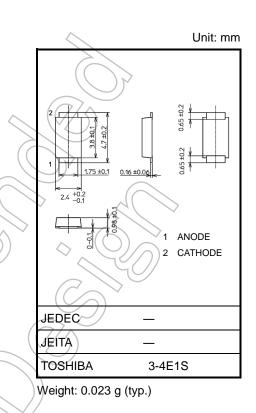
○ General-Purpose Rectifiers

- Repetitive peak reverse voltage : V_{RRM} = 600 V
- Average forward current : IF (AV) = 2.0 A
- Peak forward voltage $: V_{FM} = 1.1 V (max)$
- Suitable for high-density board assembly due to the use of a small Toshiba Nickname: M-FLATTM

Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Repetitive peak reverse voltage	VRRM	600	A
Average forward current	IF (AV)	2.0 (Note1)	A
Non-repetitive peak forward surge current	IFSM	80 (50 Hz)	A
Junction temperature	Тј	-40 to 150	Ś
Storage temperature	T _{stg}	-40 to 150	ိုင
Note 1: $T_{\ell} = 106^{\circ}C$ Device mounted	on a ceram		

board size : 50 mm × 50 mm Soldering land size : 2 mm × 2 mm board thickness : 0.64 mm



Note : Using continuously under heavy loads (e.g. the application of

Half-sine waveform : $\alpha = 180^{\circ}$

high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating

temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test

report and estimated failure rate, etc.).

Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Peak forward voltage VFM(1) VFM(2)		IFM = 1.0 A (Pulse test)		0.88	—	V
		IFM = 2.0 A (Pulse test)	-	0.92	1.1	V
Repetitive peak reverse current	IRRM	VRRM = 600 V (Pulse test)		_	10	μA
		$\begin{array}{llllllllllllllllllllllllllllllllllll$	_	_	60	
Thermal resistance (junction to ambient)	Rth (j-a)	Device mounted on a glass-epoxy board board size50 mm × 50 mmsoldering land size6 mm × 6 mmboard thickness1.6 mm	_	_	110	°C/W
		$\begin{array}{ccc} \text{Device mounted on a glass-epoxy board} \\ \text{board size} & 50 \text{ mm} \times 50 \text{ mm} \\ \text{soldering land size} & 2.1 \text{ mm} \times 1.4 \text{ mm} \\ \text{board thickness} & 1.6 \text{ mm} \end{array}$	_	_	180	
Thermal resistance (junction to lead)	Rth (j-ł)			—	16	°C/W

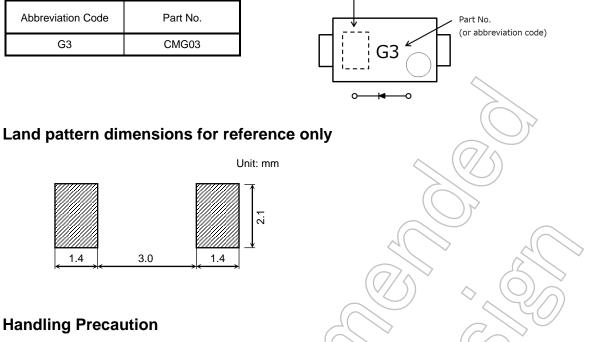
Start of commercial production 2004-06

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Marking

Abbreviation Code	Part No.		
G3	CMG03		

Cathode mark and Lot code



Handling Precaution

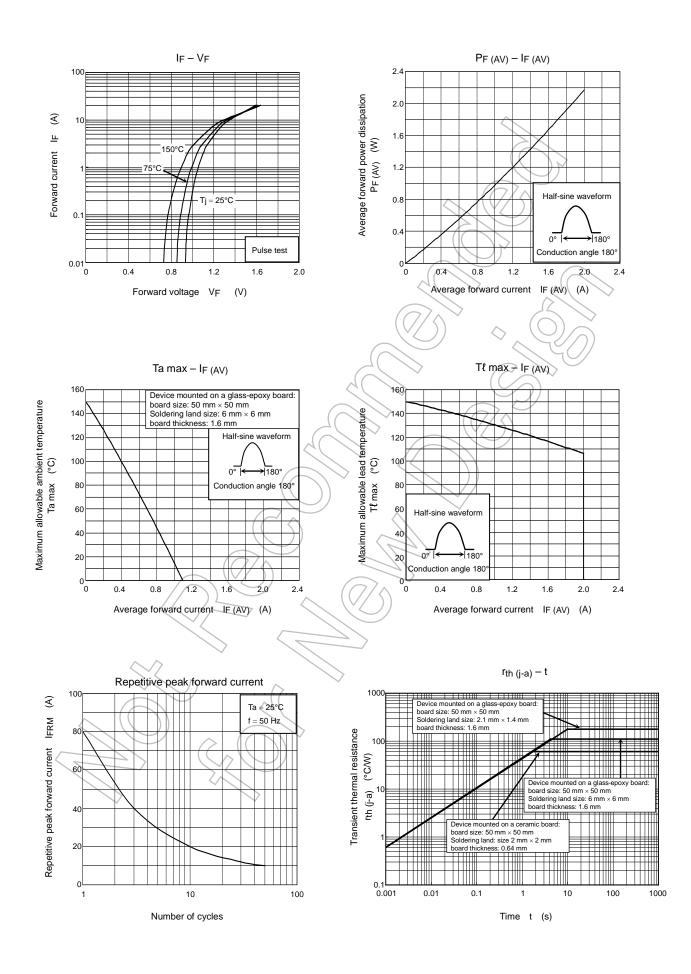
1.4

3.0

1.4

- 1) The absolute maximum ratings denote the absolute maximum ratings, which are rated values and must not be exceeded during operation, even for an instant. The following are the general derating methods that we recommend when you design a circuit with a device.
 - V_{RRM}: We recommend that the worst case voltage, including surge voltage, be no greater than 80% of the absolute maximum rating of V_{RRM} for a DC circuit and be no greater than 50% of that of V_{RRM} for an AC circuit. V_{RRM} has a temperature coefficient of 0.1%//°C. Take this temperature coefficient into account designing a device at low temperature.
 - IF(AV): We recommend that the worst case current be no greater than 80% of the absolute maximum rating of IF(AV) and Tj be below 120°C. Carry out adequate heat design. If you can't design a circuit with excellent heat radiation, set the margin by using an allowable Ta max - IF(AV) curve.
 - IFSM: This rating specifies the non-repetitive peak current in one cycle of a 50-Hz sine wave, condition angle 180. Therefore, this is only applied for an abnormal operation, which seldom occurs during the lifespan of the device.
 - : We recommend that a device be used at Ti below 120°C under the worst load and heat radiation conditions. Τj
- 2) Thermal resistance between junction and ambient fluctuates depending on the device's mounting condition. When using a device, design a circuit board and a soldering land size to match the appropriate thermal resistance value.
- 3) For other design considerations, see the Toshiba website.

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